

# 3A, 50 - 200V Ultra Fast Surface Mount Power Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Ultra Fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

## **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.110 g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	3	Α	
$V_{RRM}$	50 - 200	V	
I <sub>FSM</sub>	75	Α	
$T_{JMAX}$	175 °C		
Package	DO-214AA (SMB)		
Configuration	Single die		







DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	MUR305	MUR310	MUR315	MUR320	UNIT	
		SBH	SBH	SBH	SBH	UNII	
Marking code on the device		MUR305SB	MUR310SB	MUR315SB	MUR320SB		
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	V	
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	105	140	V	
Forward current	I <sub>F</sub>	3			Α		
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	75			А		
Junction temperature	T <sub>J</sub>	- 55 to +175			°C		
Storage temperature	T <sub>STG</sub>	- 55 to +175			°C		

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R <sub>OJL</sub>	42	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	76	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	45	°C/W	

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.79	0.85	V
	I <sub>F</sub> = 3.0A, T <sub>J</sub> = 25°C		0.86	0.90	V
	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 150°C		0.61	0.68	V
	$I_F = 3.0A, T_J = 150^{\circ}C$		0.69	0.73	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	5	μA
	T <sub>J</sub> = 150°C	l <sub>R</sub>	-	150	μA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	45	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	25	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
MUR3xSBH	DO-214AA (SMB)	3,000 / Tape & Reel		

### Notes:

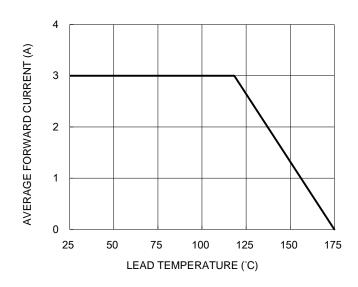
1. "x" defines voltage from 50V(MUR305SBH) to 200V(MUR320SBH)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve



**Fig.2 Typical Junction Capacitance** 

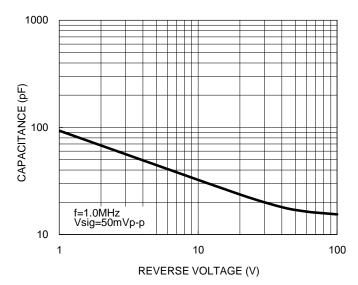
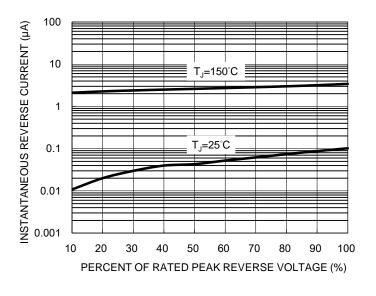
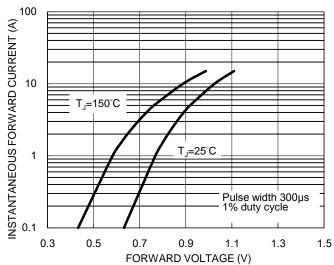


Fig.3 Typical Reverse Characteristics



**Fig.4 Typical Forward Characteristics** 

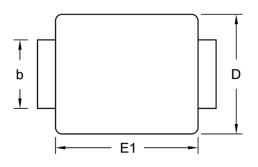


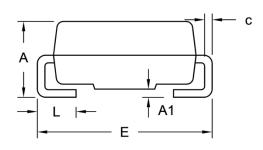


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## **PACKAGE OUTLINE DIMENSIONS**

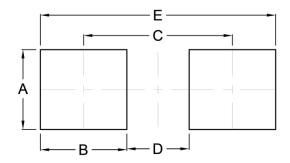
# DO-214AA (SMB)





DIM.	Unit (mm)		Unit (	(inch)
Dilvi.	Min.	Max.	Min.	Max.
Α	1.95	2.65	0.077	0.104
A1	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
С	0.15	0.31	0.006	0.012
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.60	0.030	0.063

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

# **MARKING DIAGRAM**



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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